



Product Change Notification

Change Notification #: 117255 - 00
Change Title: Select Boxed Intel® Xeon® E-2274G Processor,
 PCN 117255-00, Product Discontinuance, End of Life
Date of Publication: November 13, 2019

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

	BOXED
Product Discontinuance Program Support Begins:	November 13, 2019
Last Product Discontinuance Order Date:	November 13, 2019
Orders are Non-Cancelable and Non-Returnable After:	November 13, 2019
Last Product Discontinuance Shipment Date:	November 13, 2019

Description of Change to the Customer:

Intel® Xeon® Workstation/Server Processors E-2274G that has the DHA-A heatsink with PN# E97378-003 included does not meet the requirement for thermal performance.

Customer Impact of Change and Recommended Action:

The Boxed processor in the ("Products Affected / Intel Ordering Codes:") table below will End of Life and all inventory is being requested for return. Intel is offering a tray processor to Intel Authorized Distributors as a substitute for depleted boxed processor inventory. The substitute tray processor is identified below in the "Substitute Tray Processors" table below.

Products Affected / Intel Ordering Codes:

Boxed Processor					Substitute Tray Processor			
Marketing Name	Product Code	S-Spec	MM#	Stepping	Product Code	S-Spec	MM#	Stepping
Boxed Intel® Xeon® E-2274G Processor	BX80684E2274G	S RFDE	999JMP	U0	CM8068404174407	S RFDE	999DJL	U0

PCN Revision History:

Date of Revision: November 13, 2019	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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